

LOCTITE HHD 3565BK

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PRODUCT DESCRIPTION

LOCTITE HHD 3565BK provides the following product characteristics:

Technology	Polyurethane Hot Melt
Appearance	Black Solid
Cure	Moisture
Application	Device assembly, Bonding
Solids Content, %	100
Components	One part - requires no mixing
Product Benefits	<ul style="list-style-type: none">• Bond strength• Pressure sensitive• Fast fixture time

LOCTITE HHD 3565BK is a reactive, black polyurethane hotmelt adhesive formulated to cure with moisture. This adhesive has a long open time and is ideal for automatic or manual assembly line production.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield - Thermosel, 110 °C, mPa·s (cP):
Spindle 27, speed 20 rpm 7,500
Density @ 25°C ±0.05, g/cm³ 1.1
Solids Content, % 100
Flash Point - See SDS

TYPICAL CURING PERFORMANCE

Open Time @ 23 °C, minutes ~2
Preheating Schedule 20 to 30 mins @ 100°C
Application Temperature, °C 90 to 110
Fixture time, min ~1

Open time is the bonding range of a 1 mm bead of molten adhesive on substrate. It is based on room temperature environment. Higher temperature will lengthen the open time while lower environmental temperatures will shorten the open time.

LOCTITE HHD 3565BK cures exclusively by moisture and gains its final strength in 1-5 days. This material, however, exhibits high handling strength instantly after bonding.

Curing is a chemical reaction depending on the following parameters:

- Humidity in the rooms of application and storage
- Moisture content on the substrates
- Permeability of the substrates to be bonded
- Application volume / layer of the adhesive film

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Pretreatment:

1. The bonding surfaces must be clean, dry and free of oil and grease.
2. Substrate temperature should not fall below 20°C during application.
3. Lower temperatures will lead to early solidification of the adhesive and to a reduced open time, the adhesive might even flake off.
4. The substrates may be preheated if necessary.

Application:

1. LOCTITE HHD 3565BK can be applied from heating cartridge guns, from usual syringe type melting equipment.
2. At longer rest periods, melting and application temperatures should be decreased. Longer exposure to higher temperatures can lead to a viscosity increase.

STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage : 5 to 25 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$
 $\text{kV/mm} \times 25.4 = \text{V/mil}$
 $\text{mm} / 25.4 = \text{inches}$
 $\text{N} \times 0.225 = \text{lb}$
 $\text{N/mm} \times 5.71 = \text{lb/in}$
 $\text{psi} \times 145 = \text{N/mm}^2$
 $\text{MPa} = \text{N/mm}^2$
 $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$
 $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$
 $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$
 $\text{mPa}\cdot\text{s} = \text{cP}$

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